

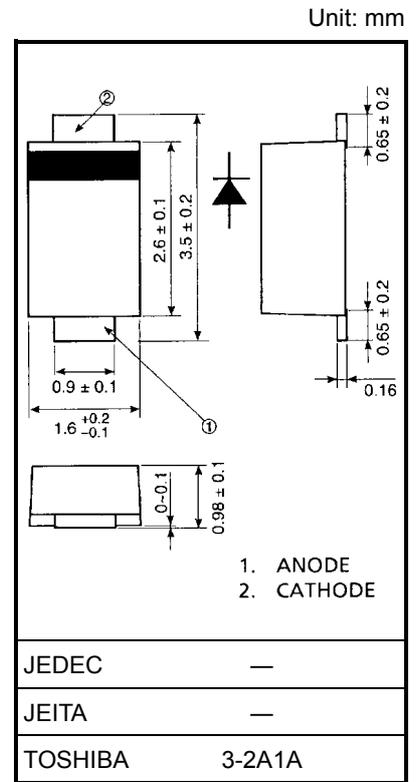
# CRH01

## Switching Mode Power Supply Applications

- Repetitive peak reverse voltage:  $V_{RRM} = 200\text{ V}$
- Average forward current:  $I_F (AV) = 1.0\text{ A}$
- Low forward voltage:  $V_{FM} = 0.98\text{ V (Max.)}$
- Very Fast Reverse-Recovery Time:  $t_{rr} = 35\text{ ns (Max.)}$
- Suitable for compact assembly due to small surface-mount package "S-FLAT™" (Toshiba package name)

## Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	$V_{RRM}$	200	V
Average forward current	$I_F (AV)$	1.0	A
Peak one cycle surge forward current (non-repetitive)	$I_{FSM}$	15 (50 Hz)	A
Junction temperature	$T_j$	-40~150	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-40~150	$^\circ\text{C}$

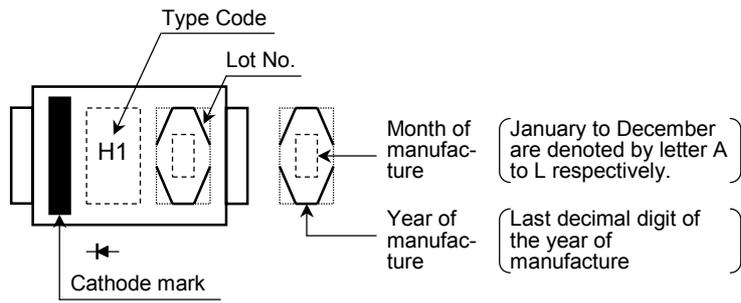


Weight: 0.013 g (typ.)

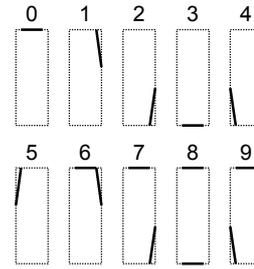
## Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM} (1)$	$I_{FM} = 0.1\text{ A}$	—	0.71	—	V
	$V_{FM} (2)$	$I_{FM} = 0.7\text{ A}$	—	0.86	—	
	$V_{FM} (3)$	$I_{FM} = 1.0\text{ A}$	—	0.90	0.98	
Repetitive peak reverse current	$I_{RRM}$	$V_{RRM} = 200\text{ V}$	—	—	10	$\mu\text{A}$
Reverse recovery time	$t_{rr}$	$I_F = 1\text{ A}$ , $di/dt = -30\text{ A}/\mu\text{s}$	—	—	35	ns
Forward recovery time	$t_{fr}$	$I_F = 1\text{ A}$	—	—	100	ns
Thermal resistance	$R_{th} (j-a)$	Device mounted on a ceramic board (soldering land: 2 mm × 2 mm)	—	—	65	$^\circ\text{C}/\text{W}$
		Device mounted on a glass-epoxy board (soldering land: 6 mm × 6 mm)	—	—	130	

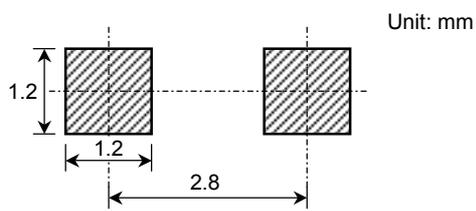
**Marking**

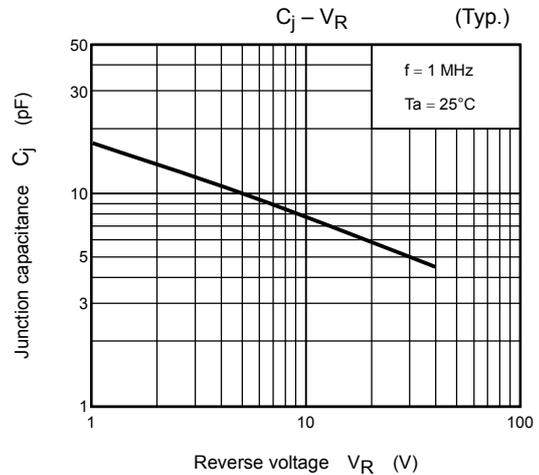
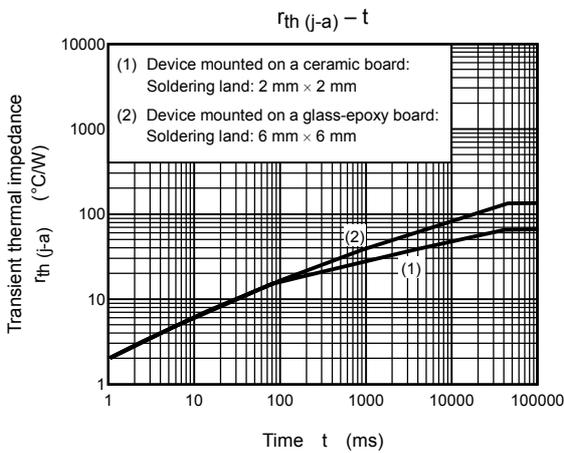
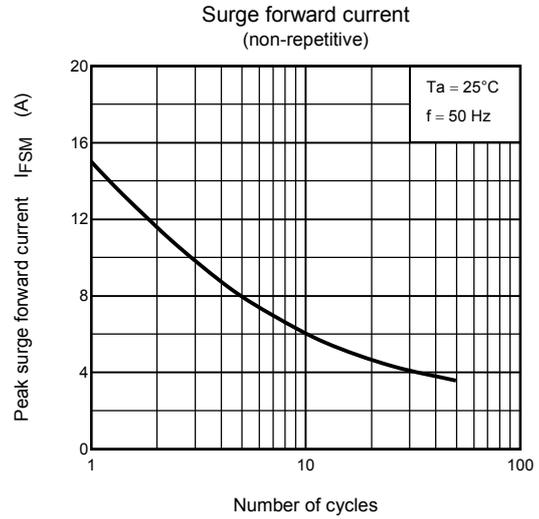
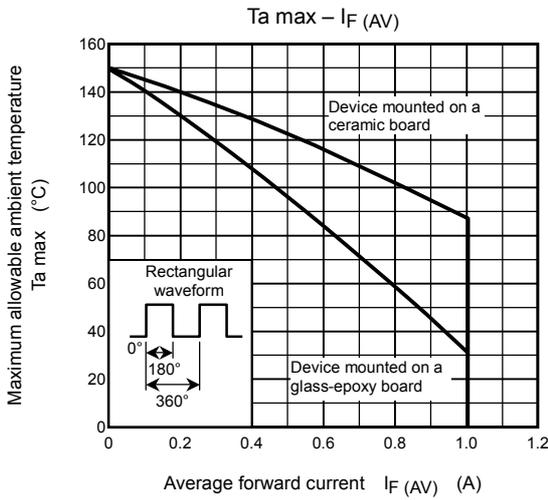
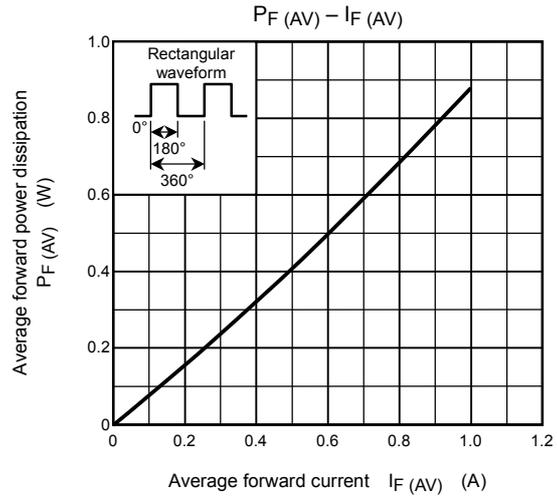
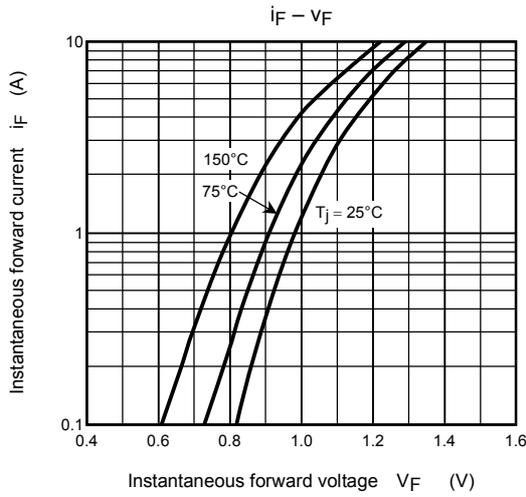


**Following Indicates the Date of Manufacture**



**Standard Soldering Pad**





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